14	n .	DECLARA	TION AND F	OWER OF	FATTORNE	Y USA/PCT		
As a be	low named invento	or, I hereby declare that:				- 33.4.3.		
(a)						idence unless otherwise stated.		
. (b)	I verily believe I am/we are the original, first and sole/joint inventor(s) of the subject matter that is embraced by and for which a patent is sought on the invention entitled. HIGH-VOLTAGE DIRECT CURRENT CABLE INSULATION AND SEMICONDUCTIVE							
	SHIELD	entine de HIGH-VOL	IAGE DIRECT CUN	RENI CABLE	INSULATION AND	SEMICONDUCTIVE		
		ion of which: Lis attach	ed hereto ().					
		k one) - 🖂 🗘 was file	d on September 16, 20	03 as (<u>6249</u>	<u>2B</u>).			
	{	FEB 1 3 2004 & Applica	tion No. <u>10/663,525</u>		_	•		
	层	S, and was	tion No. <u>10/663,525</u> amended on					
(c)								
	any amendment refer to the association of the control of the contr							
(d)	(d) I acknowledge my duty under 37 CFR 1.56 to disclose to the U.S. Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR 1.56(b). If this application is a continuation-in-part application, I acknowledge the duty to disclose all							
	information know	n to me to be material to pate	his application is a cor	itinuation-in-part	application, I acknow	ledge the duty to disclose all		
		from which priority is claimed						
(e) I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or §365(b) of any foreign application(s) for patent or inventor's								
		elow or §365(a) of any PCT i						
		low, and also identify below a ternational application having						
	equivalent i e i in	nemational application having	g a ming date before th	at of the applicat	ion on which priority	s claimed.		
		PRIOR FOREIGN APPLI	CATION(S)	PRIC	ORITY CLAIMED	CERTIFIED COPIES INCL.		
	Number	Country or PCT	Day/Month/Yea	ar Filed	_	_		
	Additional cl	aims for benefit are attached.						
	Additional ci	ainis for benefit are attached.						
- (f)	hereby Claim the	benefit under 35 U.S.C. §119	(e) of any United State	s provisional app	lication(s) listed below	, or under 35 U.S.C. §120 of		
		pplication(s), or under § 365(c) of any PCT internat	ional application	designating the United	States of America listed		
	below:							
•	US or PCT Appl	n. Serial No.	Filing Date	Status at Application Filing Date				
	10/263,328		October 7, 2002		Pending			
	PCT/US03/29070		September 16, 2003		Pending			
	☐ Additional c	laims for benefit are attached.	•					
	I hereby appoint the	he attornev(s) and/or agent(s)	at the following Custo	mer No. to prosec	cute this application ar	d to transact all business in the		
		nark Office connected therew						
		•						
				_				
			3550	3				
This ap	pointment, includir	ng the right to delegate this ap	pointment, shall also a	pply to the same	extent it is applicable	under the laws of the United States	of	
Amenc	a to any proceeding	gs established by the Patent C	ooperation Treaty.					
I hereby	declare that all sta	tements made herein of my o	wn knowledge are true	and that all state	ments made on inform	ation and belief are believed to be		
true; an	d further that these	statements are made with the	knowledge that willfu	I false statements	and the like so made	are punishable by fine or		
		ler 18 U.S.C. § 1001 and that	such willful false state	ments may jeopa	rdize the validity of the	e application or any patent issued		
thereon			1					
	Inventor(s):							
	At: Somerset, Ne	w Jersey 08873, U.S.A.		At: Somerset,	New Jersey 08873, U	.S.A.		
	this 18 day of houlnuly, 20 03			this / day of	noul	white, 2003		
						28		
	Signature:	1 1		Signatura:	Afted ale	udels du		
	Full Name:	Jinder Jow		Full Name:	Alfred Mendelsol			
	Residence:	7 Dakota Trail		Residence:	1141 East 29th St			
	_	Somerville, New Jersey 08	8876		Brooklyn, New Y			
	Country: Citizenship:	United States of America		Country:	United States of A			
	P. O. Address:	United States of America Same as Residence		Citizenship: P. O. Address:	United States of A Same as Residence			
				Address.	— and as resident			
	At:			At:				
	this day of _		, 20		of	, 20		
				•		•		
	Signature			Signature				
	Signature: Full Name:			Signature: Full Name:				
				-				
	Full Name: Residence:			Full Name: Residence:				
	Full Name:			Full Name:				

Additional names and signatures are attached.